onsemi

MOSFET - Power, N-Channel, SUPERFET[®] III, Easy-drive 650 V, 70 mΩ, 44 A

NTBL070N65S3

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

The TOLL package offers improved thermal performance and excellent switching performance thanks to Kelvin Source configuration and lower parasitic source inductance. TOLL offers Moisture Sensitivity Level 1 (MSL 1).

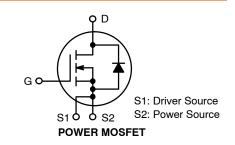
Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS}(on) = 57 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_G = 82 \text{ nC}$)
- Low Effective Output Capacitance (Typ. C_{OSS}(eff.) = 724 pF)
- 100% Avalanche Tested
- Kelvin Source Configuration and Low Parasitic Source Inductance
- MSL1 Qualified
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

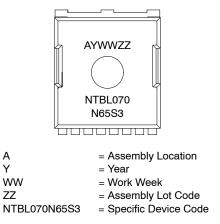
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar

BV _{DSS}	R _{DS(on)} MAX	I _D MAX		
650 V	70 m $\Omega @ 10$ V	44 A		





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol		Parameter	Value	Unit	
V _{DSS}	Drain to Source Voltage		650	V	
V _{GSS}	Gate to Source Voltage	DC	±30	V	
		AC (f > 1 Hz)	±30	V	
ID	Drain Current	Continuous (T _C = 25°C)	44	А	
		Continuous (T _C = 100°C)	28	А	
I _{DM}	Pulsed Drain Current	Pulsed (Note 1)	110	A	
E _{AS}	Single Pulsed Avalanche Energy	Pulsed Avalanche Energy (Note 2) tive Avalanche (Note 1)		mJ	
E _{AR}	Repetitive Avalanche (Note 1)			mJ V/ns	
dv/dt	dv/dt MOSFET dv/dt Peak Diode Recovery dv/dt (Note 3)		100		
			20	V/ns	
PD	Power Dissipation	$(T_{\rm C} = 25^{\circ}{\rm C})$	312	W	
	Derate Above 25°C		2.5	W/°C	
T _J ,T _{STG}	Operating and Storage Temperat	ure Range	–55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. $I_{AS} = 4.8 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} < 22 \text{ A}$, di/dt $\leq 200 \text{ A}/\mu\text{s}$, VDD $\leq \text{BVDSS}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady State	0.37	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State (Note 4)	43	

4. Device on 1 in², 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Reel Size	Tape Width	Quantity
NTBL070N65S3	NTBL070N65S3	H-PSOF8L	13 mm	24 mm	2000 Units

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS	•				
BV _{DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ mA}, \text{ T}_{J} = 25^{\circ}\text{C}$	650	-	-	V
		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$	700	-	-	V
ΔBVDSS / ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$	-	0.72	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μΑ
		V_{DS} = 520 V, V_{GS} = 0 V, Tc = 125°C	-	3.4	-	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 1.0 \text{ mA}$	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I_{D} = 22 A, T_{J} = 25°C	-	57	70	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 22 A	-	26	-	S
YNAMIC CHA	RACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	-	3300	-	pF
C _{oss}	Output Capacitance		-	72.8	-	pF
C _{rss}	Reverse Transfer Capacitance		-	14.6	-	pF
Coss(eff.)	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	724	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	104	-	pF
Q _{g(tot)}	Total Gate Charge	V_{DS} = 400 V, V_{GS} = 10 V, I_{D} = 22 A	-	82.0	-	nC
Q _{gs}	Gate to Source Gate Charge	(Note 5)	_	21	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	1	-	34.0	-	nC
R _G	Gate Resistance	f = 1 MHz	-	0.685	-	mΩ
	IARACTERISTICS	•		-		-
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}$. $I_D = 22 \text{ A}$. $V_{CS} = 10 \text{ V}$.	-	27	-	ns

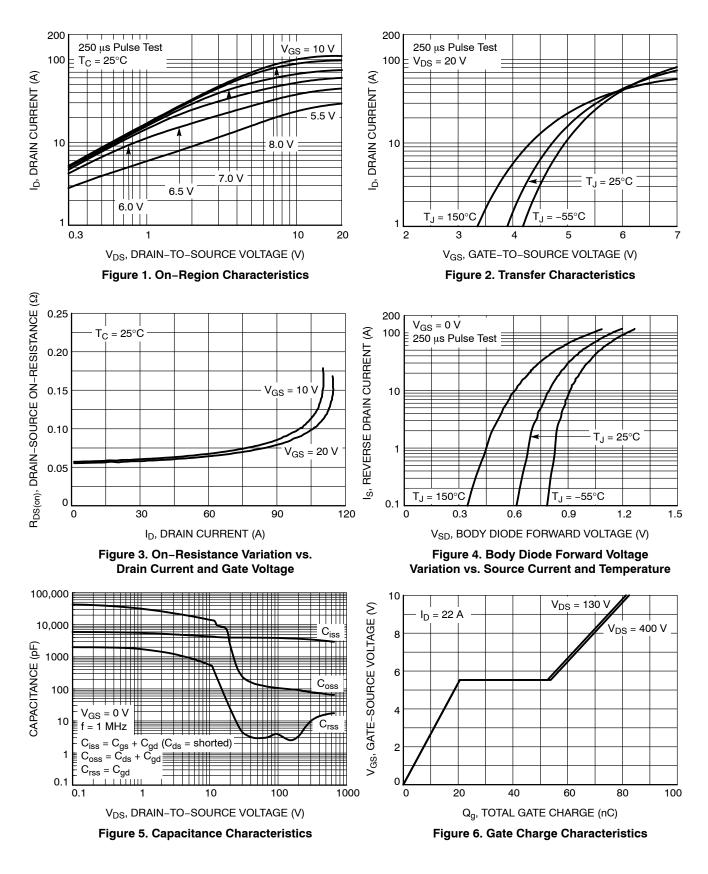
^L d(on)	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 22 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	21	_	115
t _r	Turn-On Rise Time	R _G = 4.7 Ω (Note 5)	-	24	-	ns
t _{d(off)}	Turn-Off Delay Time		-	74	-	ns
t _f	Fall Time		-	13	-	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

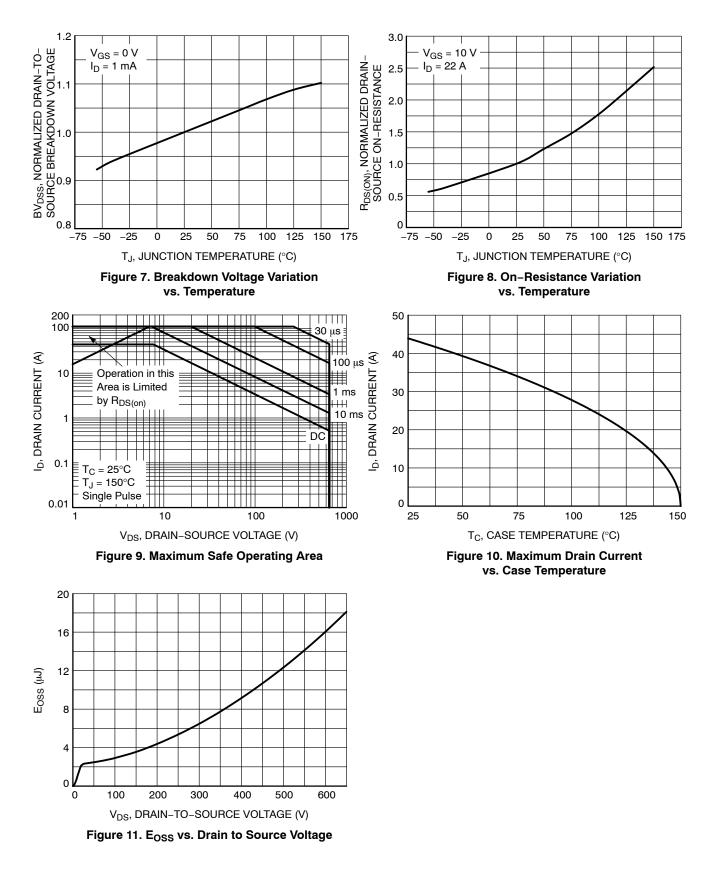
ا _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	44	А
I _{SM}	Maximum Plused Drain to Source Diode Forward Current		-	-	110	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 22 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 22 A dI_F/dt = 100 A/ μs	-	449	-	nS
Q _{rr}	Reverse Recovery Charge		-	9.5	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)



TYPICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)



TYPICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

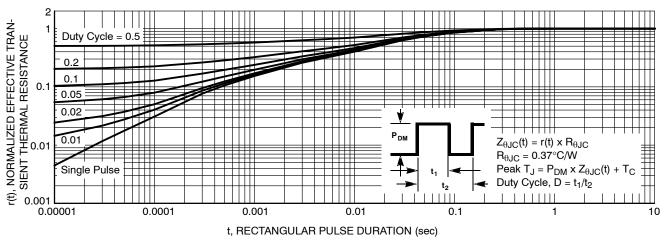


Figure 12. Transient Thermal Impedance

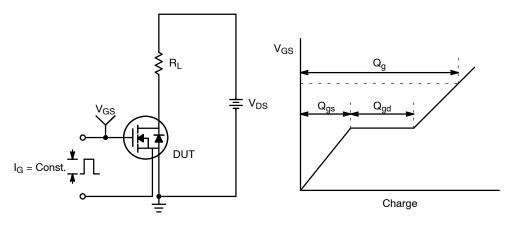


Figure 13. Gate Charge Test Circuit & Waveform

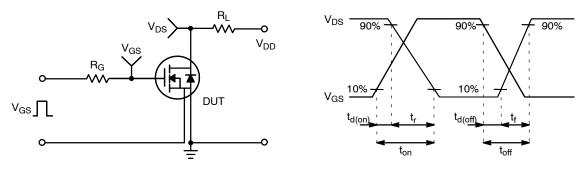
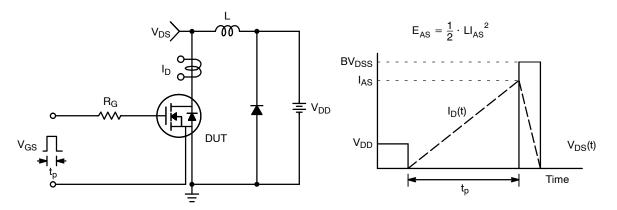


Figure 14. Resistive Switching Test Circuit & Waveforms





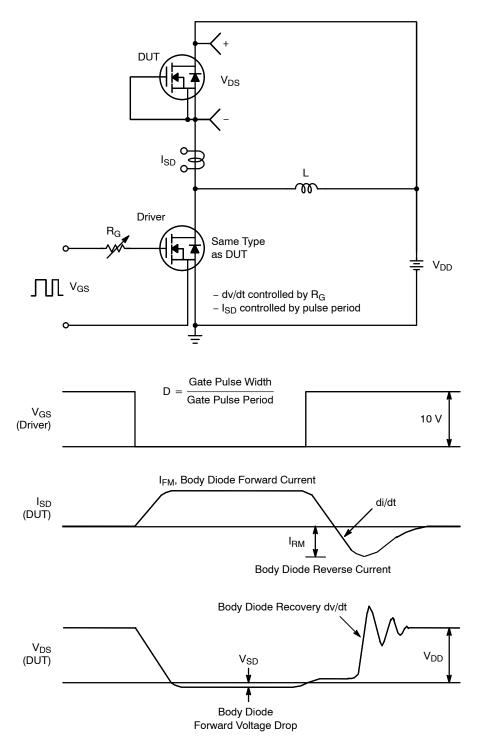
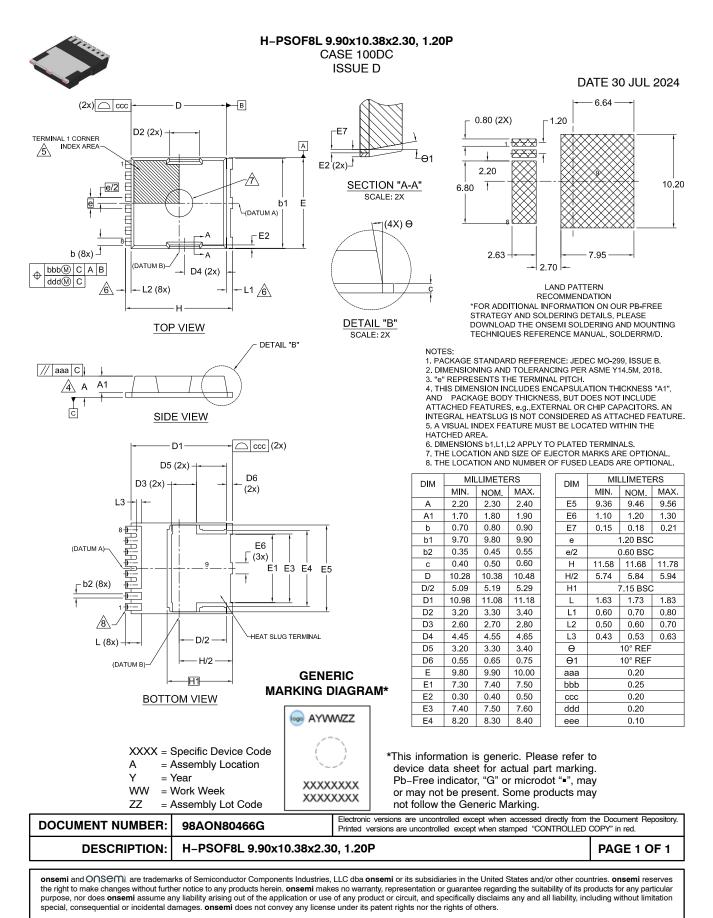


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

SUPERFET is registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

onsemi



onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi:

NTBL070N65S3